

RoHS

COMPLIANT

HALOGEN

FREE

P-Channel 20 V (D-S) MOSFET

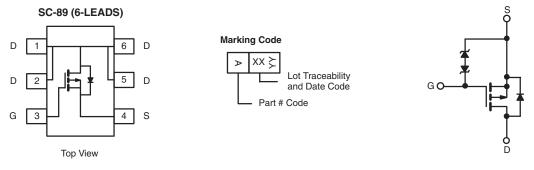
| PRODU | CT SUMMARY | | |
|---------------------|------------------------------------|--------------------|-----------------------|
| V _{DS} (V) | R _{DS(on)} (Ω) Max. | I _D (A) | Q _g (Typ.) |
| | 0.078 at V _{GS} = - 4.5 V | - 1.4 | |
| - 20 | 0.098 at V _{GS} = - 2.5 V | - 1 | 12.1 nC |
| - 20 | 0.130 at V _{GS} = - 1.8 V | - 1 | 12.1110 |
| | 0.188 at V _{GS} = - 1.5 V | - 0.3 | |

FEATURES

- TrenchFET[®] Power MOSFET
- Typical ESD Performance 2500 V
- 100 % R_g Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Load Switch for Portable Devices
- Power Management



Ordering Information: Si1077X-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

| ABSOLUTE MAXIMUM RATING | S (T _A = 25 °C, unl | ess otherwise | e noted) | | |
|--|---------------------------------------|-----------------------------------|------------------------|------|--|
| Parameter | | Symbol | Limit | Unit | |
| Drain-Source Voltage | | V _{DS} | - 20 | v | |
| Gate-Source Voltage | | V _{GS} | ± 8 | v | |
| Continuous Drain Current ($T_{,1} = 150 \text{ °C}$) | T _A = 25 °C | 1 | - 1.75 ^{b, c} | | |
| Continuous Drain Current (1) = 100 C) | T _A = 70 °C | I _D | - 1.4 ^{b, c} | | |
| Pulsed Drain Current (t = 300 µs) | · | I _{DM} | - 8 | A | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | ۱ _S | - 0.28 ^{b, c} | | |
| Maximum Power Dissigation | T _A = 25 °C | P _D | 0.33 ^{b, c} | W | |
| Maximum rower Dissipation | T _A = 70 °C | | 0.21 ^{b, c} | _ vv | |
| Operating Junction and Storage Temperature R | ange | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum handling to Ambigueta b | t ≤ 5 s | R _{thJA} | 300 | 375 | °C/W |
| Maximum Junction-to-Ambient ^{a, b} | Steady State | ''thJA | 360 | 450 | 0/00 |

Notes:

a. Maximum under steady state conditions is 450 $^{\circ}\text{C/W}.$

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

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Si1077X

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-------------------------|--|---------------------------|--------|-------|----------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = -250 \mu A$ | - 20 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | L 050 A | | - 11 | | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = - 250 μA | | 2.4 | | mV/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 0.4 | | - 1 | V | |
| | | $V_{DS} = 0 V, V_{GS} = \pm 8 V$ | | | ± 10 | | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 4.5 V$ | | | ± 1 | | |
| | | V _{DS} = - 20 V, V _{GS} = 0 V | | | - 1 | μΑ | |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 85 °C | | | - 10 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = \ge -5 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}$ | - 8 | | | Α | |
| | (*) | V _{GS} = - 4.5 V, I _D = - 1.8 A | | 0.065 | 0.078 | <u> </u> | |
| | _ | V _{GS} = - 2.5 V, I _D = - 1 A | | 0.081 | 0.098 | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 1.8 V, I _D = - 1 A | | 0.100 | 0.130 | Ω | |
| | | V _{GS} = - 1.5 V, I _D = - 0.3 A | | 0.125 | 0.188 | 1 | |
| Forward Transconductance | 9 _{fs} | V _{DS} = - 10 V, I _D = - 1.8 A | | 10 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 965 | | | |
| Output Capacitance | C _{oss} | V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz | | 110 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 101 | | | |
| | | V _{DS} = - 10 V, V _{GS} = - 8 V, I _D = - 1.75 A | | 20.7 | 31.1 | | |
| Total Gate Charge | Q_g | | | 12.1 | 18.2 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.75 \text{ A}$ | | 1.85 | | nC | |
| Gate-Drain Charge | Q _{gd} | | | 2.21 | | | |
| Gate Resistance | R _g | f = 1 MHz | 3.6 | 18 | 36 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 24 | 36 | | |
| Rise Time | t _r | V_{DD} = - 10 V, R _L = 7.1 Ω | | 17 | 26 | 1 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong$ - 1.4 A, V_{GEN} = - 4.5 V, R_q = 1 Ω | | 95 | 145 | ns | |
| Fall Time | t _f | | | 28 | 42 | | |
| Turn-On Delay Time | t _{d(on)} | | | 5 | 10 | | |
| Rise Time | t _r | V_{DD} = - 10 V, R _L = 7.1 Ω | | 8 | 16 | 1 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D = -1.4 \text{ A}, V_{GEN} = -8 \text{ V}, \text{R}_g = 1 \Omega$ | | 115 | 173 | ns | |
| Fall Time | t _f | | | 26 | 39 | | |
| Drain-Source Body Diode Characteris | | | | I | I | 1 | |
| Pulse Diode Forward Current ^a | I _{SM} | | | | - 8 | A | |
| Body Diode Voltage | V _{SD} | I _S = - 1.4 A | | - 0.75 | - 1.2 | v | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 16 | 24 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 7 | 14 | nC | |
| Reverse Recovery Fall Time | t _a | I _F = - 1.4 A, dl/dt = 100 A/μs | - 1.4 A, dl/dt = 100 A/µs | | | | |
| | t _b | 4 | | 7 | ł | ns | |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

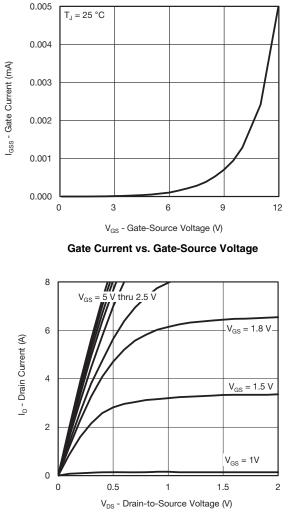
b. Guaranteed by design, not subject to production testing.

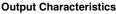
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

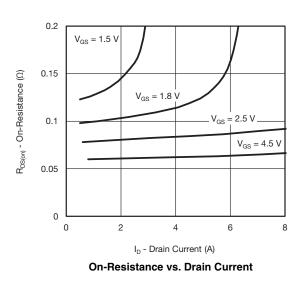
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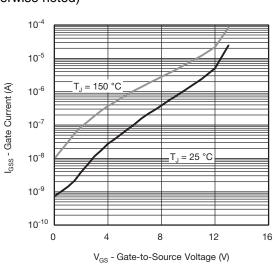


TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

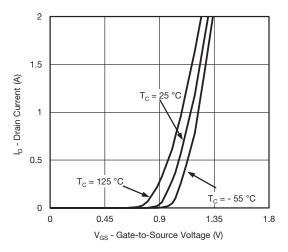




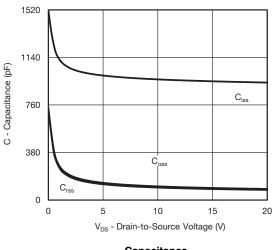




Gate Current vs. Gate-to-Source Voltage



Transfer Characteristics Curves vs. Temperature



Capacitance

For technical questions, contact: pmostechsupport@vishay.com

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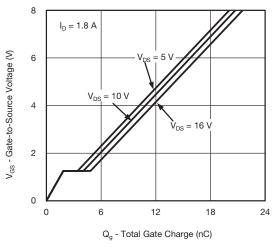
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Si1077X

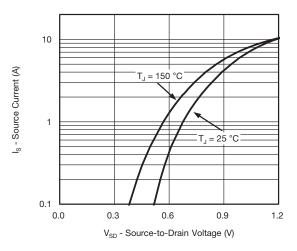
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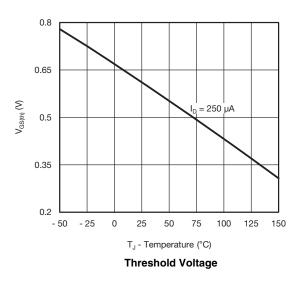
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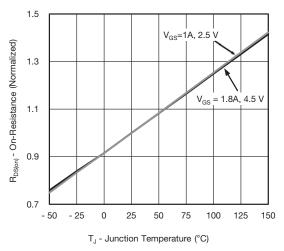




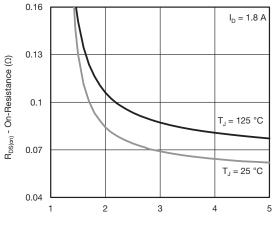


Source-Drain Diode Forward Voltage



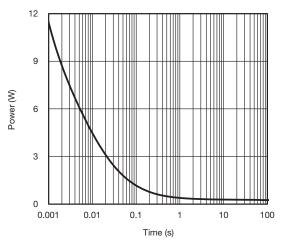


On-Resistance vs. Junction Temperature



V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

Document Number: 63254 S12-3081-Rev. A, 24-Dec-12

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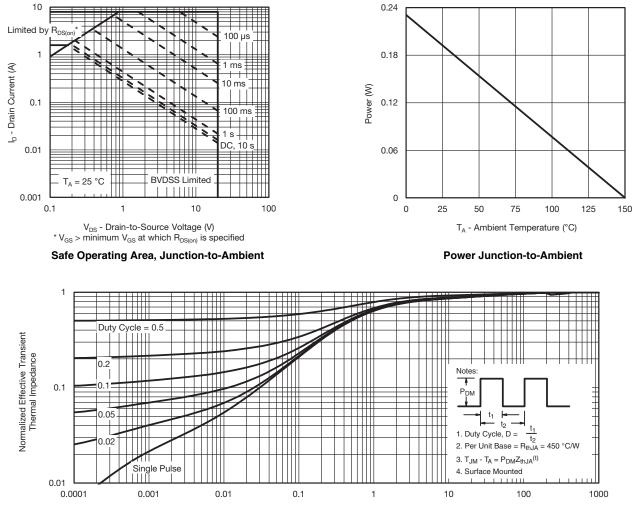
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Si1077X Vishay Siliconix

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63254.



Vishay Siliconix

SC-89 6-Leads (SOT-563F)



Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

A Datums A, B and D to be determined 0.10 mm from the lead tip.

 \triangle Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.









| DIM. | MILLIMETERS | | | | |
|---------------------------|-----------------|------|------|--|--|
| | MIN. | NOM. | MAX. | | |
| А | 0.56 | 0.58 | 0.60 | | |
| A1 | 0 | 0.02 | 0.10 | | |
| b | 0.15 | 0.22 | 0.30 | | |
| С | 0.10 | 0.14 | 0.18 | | |
| D | 1.50 | 1.60 | 1.70 | | |
| E | 1.50 | 1.60 | 1.70 | | |
| E1 | 1.15 | 1.20 | 1.25 | | |
| е | 0.45 | 0.50 | 0.55 | | |
| e1 | 0.95 | 1.00 | 1.05 | | |
| L | 0.25 | 0.35 | 0.50 | | |
| L1 | 0.10 | 0.20 | 0.30 | | |
| C14-0439-Rev DWG: 5880 | v. C, 11-Aug-14 | | | | |

Revision: 11-Aug-14

1 For technical questions, contact: <u>analogswitchtechsupport@vishay.com</u> Document Number: 71612

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Application Note 826

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RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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